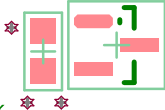
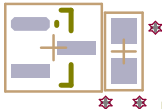


- 3.3V
- GND
- SIG



Back
Right





Back
Left



3.3V 
GND 
SIG 

Layer Informations

Layer Number	Layer Name	Layer Function
m1	PCB outline	pcb outline
m2	Drawing	generell drawing
m10	Manufacturer Info	pcb fabrication info
m11	Designator	TOP assembly info top
m12	Designator	BOT assembly info bottom
m13	Parts Top	parts body outline, 3D parts top
m14	Parts BOT	parts body outline, 3D parts bot
m15	Courtyard TOP	parts courtyard, part centre top
m16	Courtyard BOT	parts courtyard, part centre bot

Layer Stack Up

Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0,010mm	3,5	
1	Top Layer	Copper	0,036mm		
	Dielectric 1	FR-4	0,900mm	4,8	
2	Bottom Layer	Copper	0,036mm		
	Bottom Solder	Solder Resist	0,010mm	3,5	
	Bottom Overlay				